

TOLERANCE:	
X.X	±0.30
X.XX	±0.25
X.XXX	±0.15

DATE :	2014-02-23
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CHECKED BY:
马跃

DATE :	2014-02-23
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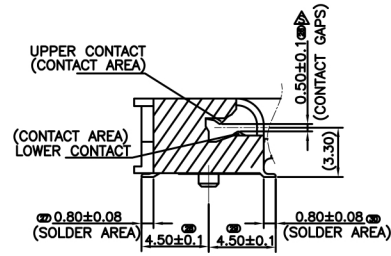
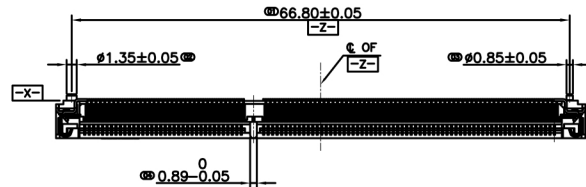
APPROVED BY:

邱敏

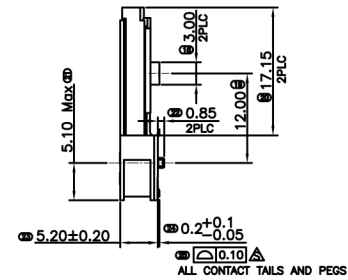
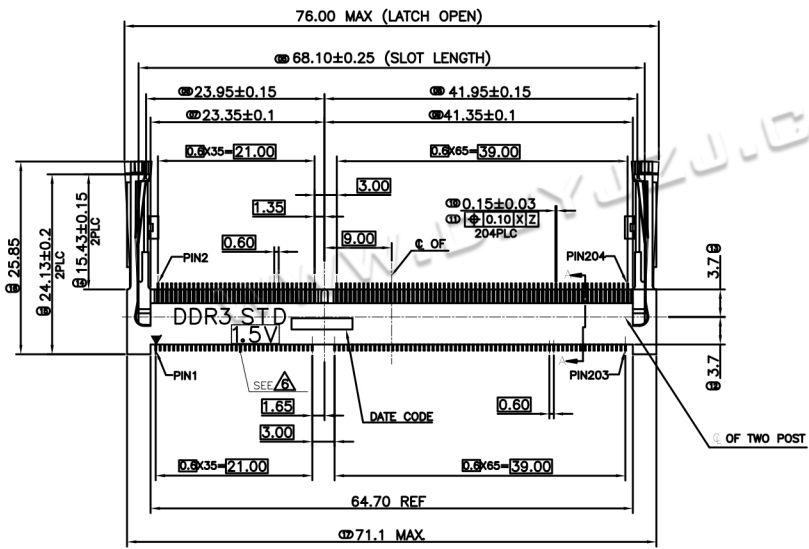
DATE :	2014-02-23
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DRAW NO:	HYC-2207041314
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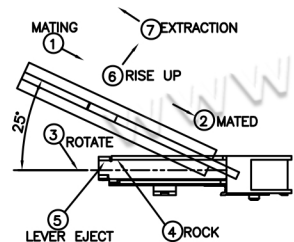
SHEET NO.	1 OF 1
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SECTION A-A
SCALE 2:1

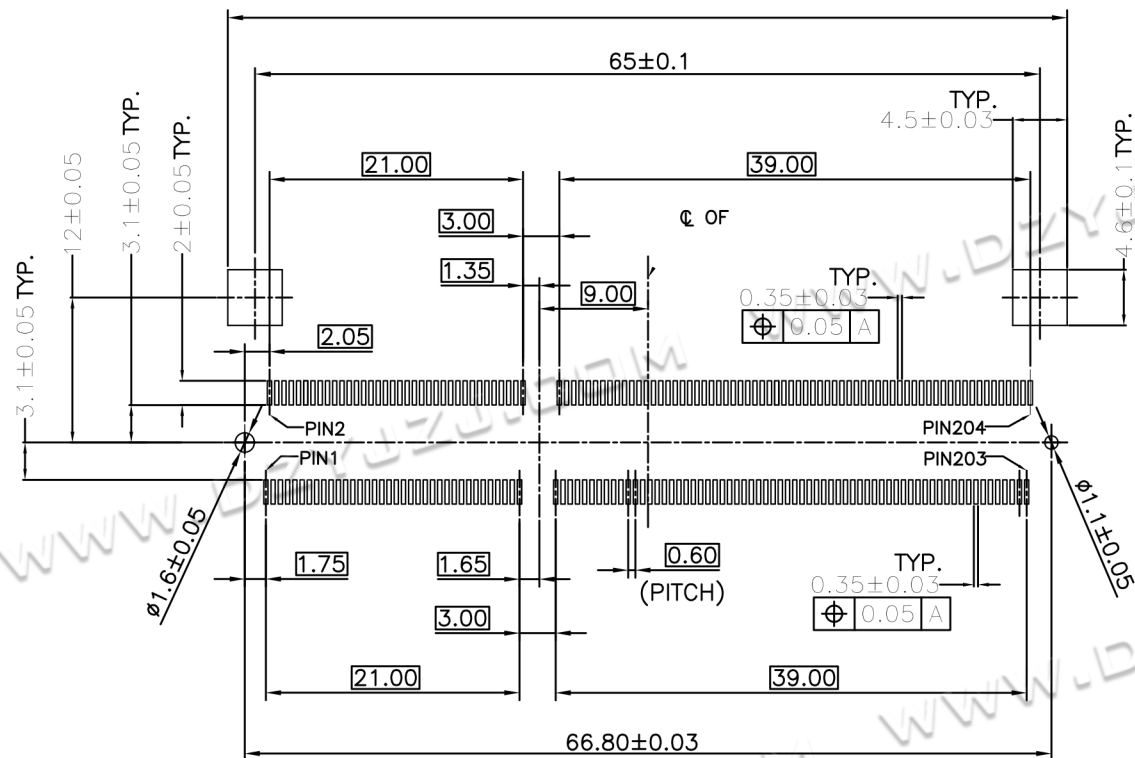


1. MATERIAL:
1.1 HOUSING: HIGH TEMPERATURE THERMOPLASTIC, UL94V-0;
COLOR: BLACK.
1.2 CONTACTS: COPPER ALLOY
1.3 LATCH: STAINLESS STEEL
1.4 FLOATING PEG: STAINLESS STEEL
2. FINISH:
2.1 CONTACT:
GOLD FLASH PLATED ON CONTACT AREA AND GOLD 2u"
SOLDER AREA. 50u" MIN. NICKEL UNDERPLATING.
2.2 FLOATING PEG:
GOLD FLASH PLATED ON SOLDERING AREA.
50u" MIN. NICKEL UNDERPLATING.
3. REFLOW SOLDER CAPABLE TO 260°C.
4.  SHOULD BE MEASURED BY CPK
5.  DIMENSIONS NEED BE CONTROLLED IN FAI.



HOW TO MATE AND UNMATE

MATE: ① → ④
UNMATE: ⑤ → ⑦

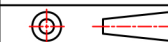


深圳市华宇创精密电子有限公司

TOLERANCE:

X.X ±0.30
X.XX ±0.25
X.XXX ±0.15

X' ±2' X.X' ±0.5'



UNIT: mm [inch]

SCALE:1:1 SIZE: A4

DRAWN BY :

陈一鸣

CHECKED BY:

马跃

APPROVED BY:

邱敏

DATE :

2014-02-23

DATE :

2014-02-23

DATE :

2014-02-23

PART NAME:

DDR3 5.2H 正向

PART NO.

HYC20-DDR3-520S

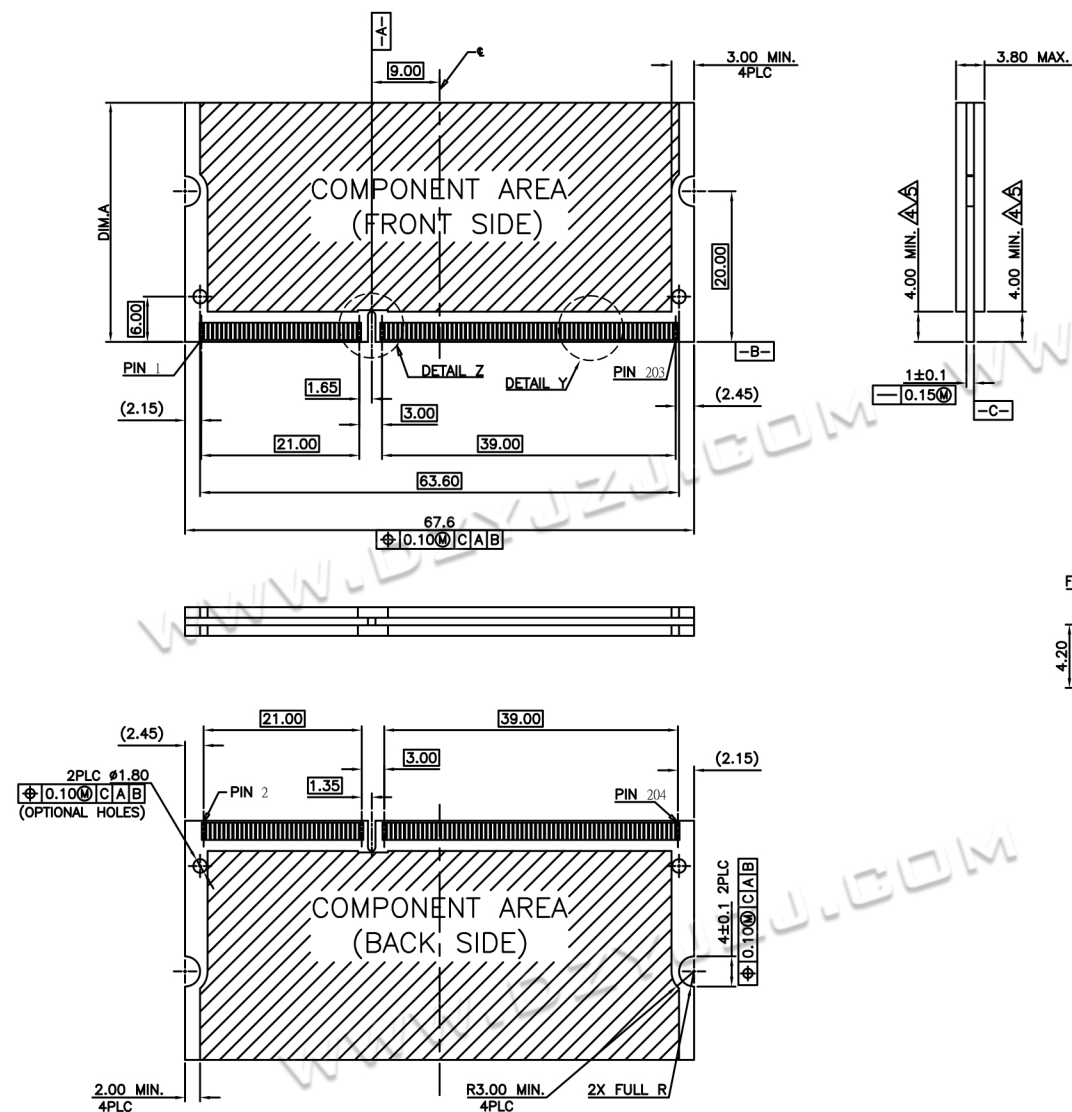
MOLD NO.

DRAW NO:

HYC-2207041314

SHEET NO.

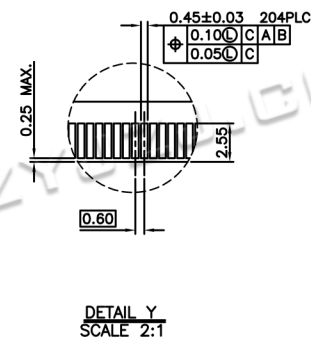
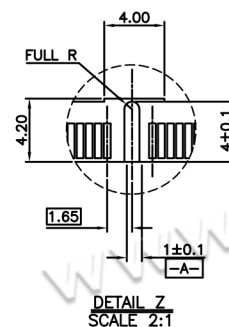
1 OF 1



RECOMMENDED MATING P.C.B CONFIGURATION

NOTE:

1. TOLERANCES ON ALL DIMENSIONS ± 0.15 UNLESS OTHERWISE SPECIFIED.
2. P.C.BOARD THICKNESS APPLIES ACROSS TABS AND INCLUDES PLATING AND/OR MENTAIZATION.
3. FINISH OF PAD:GOLD PLATING 0.00076MIN OVER ON PLATING 0.002MIN.
4. DIMENSIONS APPLICABLE WHEN COMPONENTS MOUNTED ON BOTH SIDE.
5. PCB THICKNESS NOT TO BE EXCEEDED OUTSIDE OF COMPONENT AREA.
6. REFER TO JEDEC SPEC. MO-268 FOR COMPLETE MODULE.



30.00	CA
31.75	BA
25.40	AA
DIM. A	SDRAM VARIATIONS

 深圳市华宇创精密电子有限公司			
TOLERANCE: X.X ± 0.30 X.XX ± 0.25 X.XXX ± 0.15 X.X' $\pm 2'$ X.X' $\pm 0.5'$	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: DDR3 5.2H 正向
 UNIT: mm [inch] SCALE:1:1 SIZE: A4	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HYC20-DDR3-520S
	APPROVED BY: 邱敏	DATE : 2014-02-23	MOLD NO.
	DRAW NO: HYC-2207041314		
SHEET NO. 1 OF 1			